



## Features

- 800W Peak Pulse Power Dissipation
- Uni- and Bi-Directional Versions Available
- Excellent Clamping Capability
- Glass Passivated Die Construction
- Low inductance
- Fast Response Time
- Plastic Material: UL Flammability Classification Rating 94V-0



SMB  
(DO-214AA)

## Mechanical Data

- Case: SMB Molded plastic body
- Terminals: Solderable per MIL-STD-750, Method 2026

## Applications

- I/O interface
- AC/DC power supply
- Low frequency signal transmission line (RS232, RS485, etc.)

## Maxmim Ratings (Ta=25°C unless otherwise noted)

Peak pulse power dissipation at 10/1000μs waveform (Note1, Note2, Fig.1)	P <sub>PPM</sub>	800	W
Peak pulse current	I <sub>PP</sub>	3.7	A
Steady state power dissipation at T <sub>A</sub> =50°C (Fig.5)	P <sub>M(AV)</sub>	1	W
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load, (JEDEC Method) (Note3, Fig.6)	I <sub>FSM</sub>	100	A
Operating junction and Storage Temperature Range.	T <sub>J, T<sub>STG</sub></sub>	-55 to +150	°C
Typical thermal resistance junction to lead	R <sub>θ<sub>JL</sub></sub>	30	°C/W
Typical thermal resistance junction to ambient	R <sub>θ<sub>JA</sub></sub>	100	°C/W

Notes:1. Non-repetitive current pulse, per Fig.3 and derated above T<sub>A</sub>=25°C per Fig.2.

2. Mounted on 5.0mm×5.0mm (0.03mm thick) copper pads to each terminal.

3. 8.3ms single half sine-wave, or equivalent square wave, duty cycle=4 pulses per minutes maximum.

## Electrical Characteristics (Ta=25°C)

Part Number		Device Marking Code		Reverse Stand-Off Voltage	Breakdown Voltage @I <sub>T</sub>	Test Current	Maximum Clamping Voltage @I <sub>PP</sub>	Peak Pulse Current	Reverse Leakage @V <sub>RWM</sub>
Unidirectional	Bidirectional	UNI	BI	V <sub>RWM</sub> (V)	V <sub>BR</sub> (V)	I <sub>T</sub> (mA)	V <sub>c</sub> (V)	I <sub>PP</sub> (A)	I <sub>R</sub> (μA)
HSMBJ100A13F	HSMBJ100CA13F	NZ	NZ	100.0	111.0-123.0	1	162.0	3.7	1



### Ratings and Characteristic Curves ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Figure 1. Peak Pulse Power Rating Curve

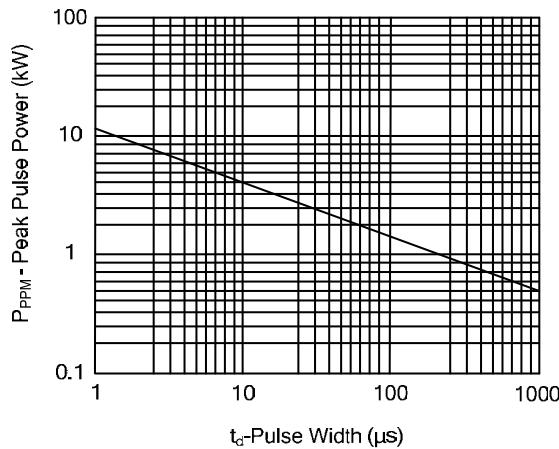


Figure 2. Pulse Derating Curve

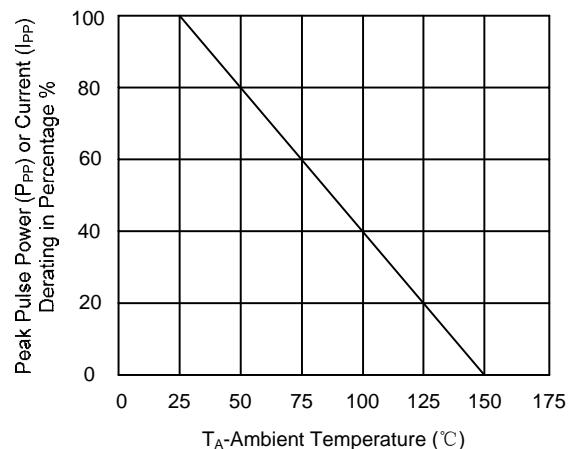


Figure 3. Pulse Waveform

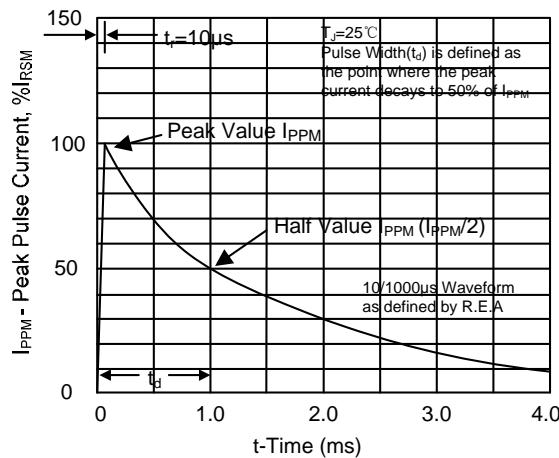


Figure 5. Steady State Power Dissipation Derating Curve

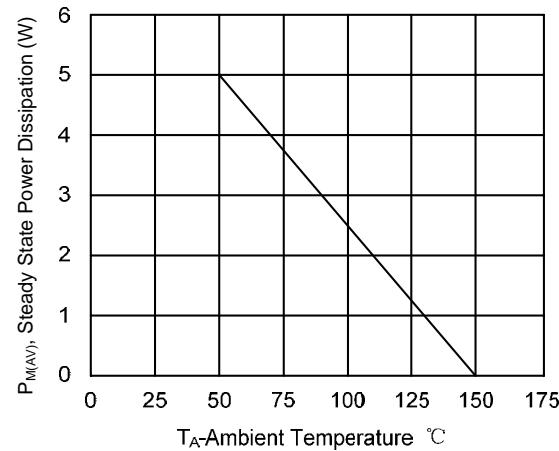


Figure 4. Typical Junction Capacitance

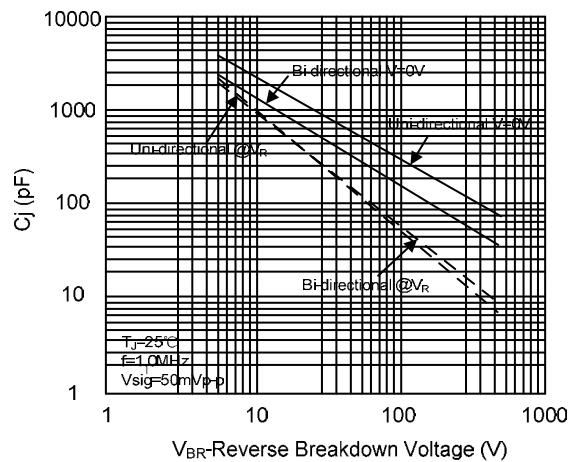
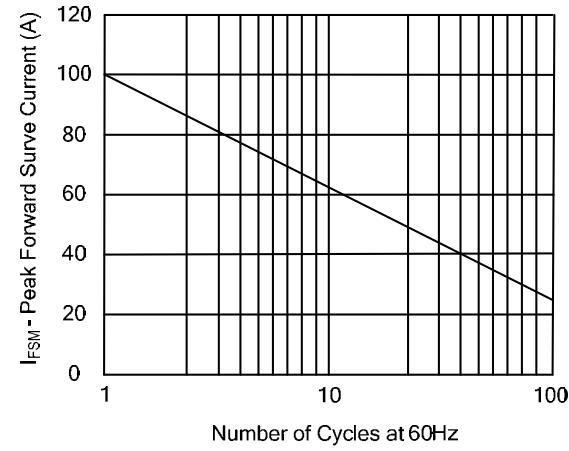


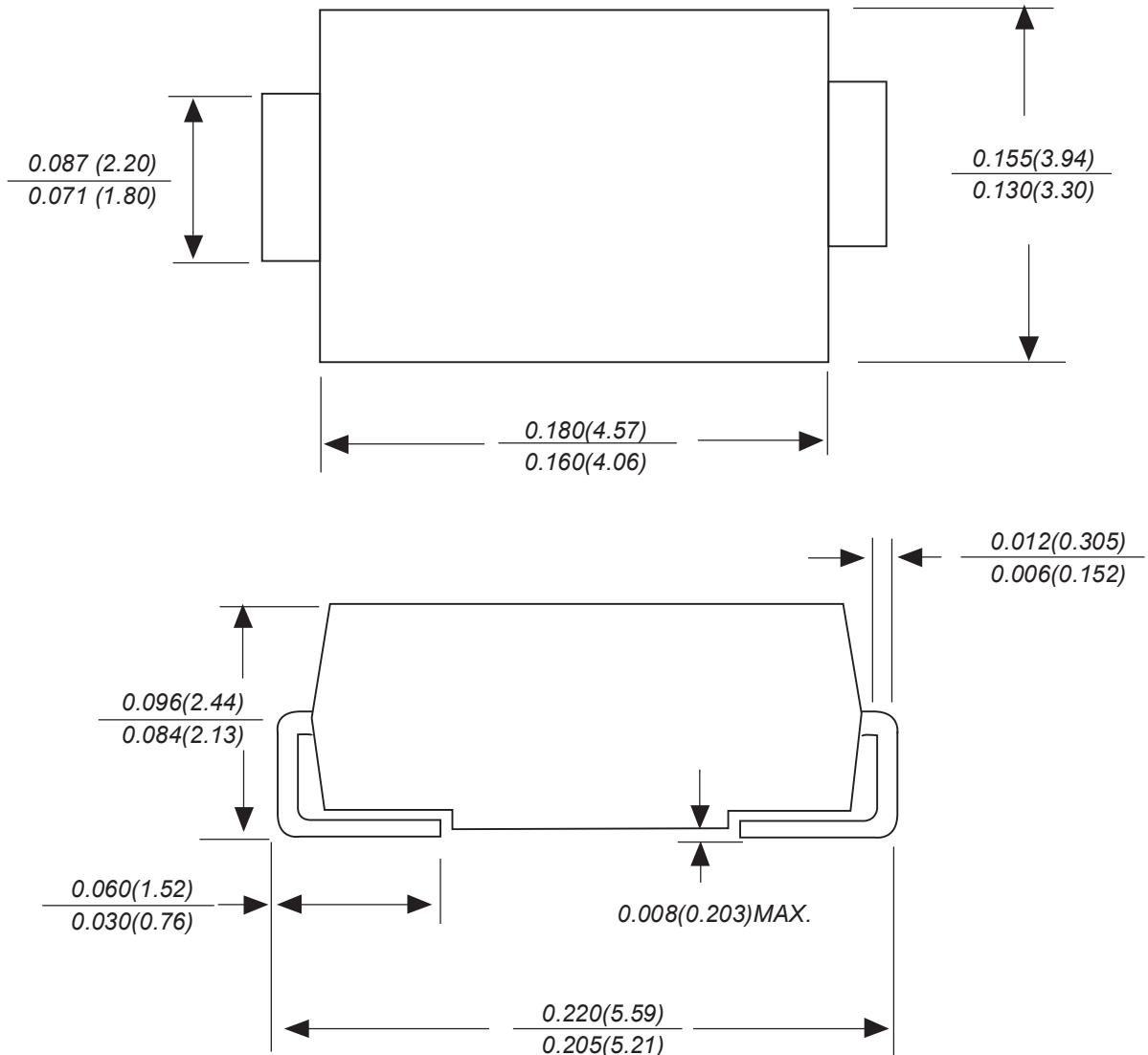
Figure 6. Maximum Non-Repetitive Forward Surge Current Uni-Directional Only





## Package Outline Dimensions

SMB(DO-214AA)



*Dimensions in inches and (millimeters)*



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